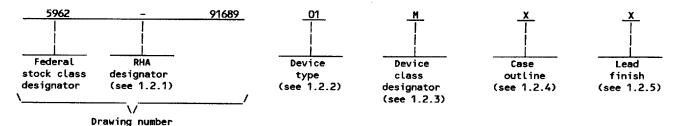
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OF SHEETS				SHI	EET		1	2	3	4	5	6	7	8	9	10	11	12	13	
PMIC N/A STAND				Marc	RED B	Kelleh	er			DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444										
MILITARY DRAWING  THIS DRAWING IS AVAILABLE FOR USE BY ALL DEPARTMENTS AND AGENCIES OF THE DEPARTMENT OF DEFENSE		Charles E Besore  APPROVED BY  Michael A Frye  DRAWING APPROVAL DATE				MICROCIRCUIT, LINEAR, BRUSHLESS DC MOTOR CONTROLLER, MONOLITHIC SILICO														
AMSC N/A			93-07-07 REVISION LEVEL				1 1			GE CODE 67268		5962-91689								
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DISTRIBUTION STATEMENT A. Approved for public release; distribution is unlimited.

5962-E185-93

### 1. SCOPE

- 1.1 <u>Scope</u>. This drawing forms a part of a one part one part number documentation system (see 6.6 herein). Two product assurance classes consisting of military high reliability (device classes B, Q, and M) and space application (device classes S and V), and a choice of case outlines and lead finishes are available and are reflected in the Part or Identifying Number (PIN). Device class M microcircuits represent non-JAN class B microcircuits in accordance with 1.2.1 of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices". When available, a choice of Radiation Hardness Assurance (RHA) levels are reflected in the PIN.
  - 1.2 PIN. The PIN shall be as shown in the following example:



- 1.2.1 <u>RHA designator</u>. Device classes M, B, and S RHA marked devices shall meet the MIL-M-38510 specified RHA levels and shall be marked with the appropriate RHA designator. Device classes Q and V RHA marked devices shall meet the MIL-I-38535 specified RHA levels and shall be marked with the appropriate RHA designator. A dash (-) indicates a non-RHA device.
  - 1.2.2 <u>Device type(s)</u>. The device type(s) shall identify the circuit function as follows:

Device type Generic number Circuit function

O1 UC1625 Brushless DC motor controller

1.2.3 <u>Device class designator</u>. The device class designator shall be a single letter identifying the product assurance level as follows:

Device class

### Device requirements documentation

М

Vendor self-certification to the requirements for non-JAN class B

microcircuits in accordance with 1.2.1 of MIL-STD-883

B or S

Certification and qualification to MIL-M-38510

Q or V

Certification and qualification to MIL-I-38535

1.2.4 <u>Case outline(s)</u>. The case outline(s) shall be as designated in MIL-STD-1835 and as follows:

Outline letter	Descriptive designator	<u>Terminals</u>	<u>Package style</u>
X	GDIP1-T28 or CDIP2-T28	28	Dual-in-line

1.2.5 <u>Lead finish</u>. The lead finish shall be as specified in MIL-M-38510 for classes M, B, and S or MIL-I-38535 for classes Q and V. Finish letter "X" shall not be marked on the microcircuit or its packaging. The "X" designation is for use in specifications when lead finishes A, B, and C are considered acceptable and interchangeable without preference.

STANDARDIZED MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	SIZE A		5962-91689
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**■ 7004708 0012593 717 ■** 

# 1.3 Absolute maximum ratings. 1/, 2/ V<sub>CC</sub> supply voltage (V<sub>CC</sub>) . . . . . . . . . . . . . . . . +20 V . . . . . . . . . -1.3 V to 6 V ISENSE1, ISENSE2 voltage OV-COAST, DIR, SPEED-IN, H1, H2, H3 voltage . . . . . . -0.3 V to 8 V S START, QUAD SEL voltage . . . . . . . . . . . . . . . . . . -0.3 V to 8 V PU output voltage . . . . . . . . . . . . . . . . . . -0.3 V to 50 V TACH-OUT output current . . . . . . . . . . . . . . . . . . ±10 mA Lead temperature (soldering, 10 seconds) . . . . . . . +300°C Thermal resistance, junction-to-case $(\Theta_{JC})$ . . . . . . 16°C/W max Thermal resistance, junction-to-ambient $(\Theta_{JA})$ . . . . . . 65°C/W 1.4 Recommended operating conditions. Ambient operating temperature range ( $T_A$ ) . . . . . . . -55°C to +125°C 2. APPLICABLE DOCUMENTS Government specifications, standards, bulletin, and handbook. Unless otherwise specified, the following specifications, standards, bulletin, and handbook of the issue listed in that issue of the Department of Defense Index of Specifications and Standards specified in the solicitation, form a part of this drawing to the extent specified herein. **SPECIFICATIONS** MILITARY - Microcircuits, General Specification for. MIL-M-38510 MIL-1-38535 - Integrated Circuits, Manufacturing, General Specification for. STANDARDS MILITARY MIL-STD-480 - Configuration Control-Engineering Changes, Deviations and Waivers. MIL-STD-883 - Test Methods and Procedures for Microelectronics. MIL-STD-1835 - Microcircuit Case Outlines. BULLETIN **MILITARY** MIL-BUL-103 - List of Standardized Military Drawings (SMD's). Currents are positive into and negative out of the specified terminal. $\overline{2}$ / Stresses above the absolute maximum rating may cause permanent damage to the device. Extended operation at the maximum levels may degrade performance and affect reliability. $\underline{3}$ / Derate at 15 mW/°C for T<sub>A</sub> > 25°C. SIZE 5962-91689 STANDARDIZED MILITARY DRAWING A DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444 REVISION LEVEL SHEET 3

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#### HANDBOOK

#### MILITARY

MIL-HDBK-780 - Standardized Military Drawings.

(Copies of the specifications, standards, bulletin, and handbook required by manufacturers in connection with specific acquisition functions should be obtained from the contracting activity or as directed by the contracting activity.)

2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing shall take precedence.

#### REQUIREMENTS

- 3.1 <u>Item requirements</u>. The individual item requirements for device class M shall be in accordance with 1.2.1 of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices" and as specified herein. The individual item requirements for device classes B and S shall be in accordance with MIL-M-38510 and as specified herein. For device classes B and S, a full electrical characterization table for each device type shall be included in this SMD. The individual item requirements for device classes Q and V shall be in accordance with MIL-I-38535, the device manufacturer's Quality Management (QM) plan, and as specified herein.
- 3.2 <u>Design, construction, and physical dimensions</u>. The design, construction, and physical dimensions shall be as specified in MIL-M-38510 for device classes M, B, and S and MIL-I-38535 for device classes Q and V and herein.
  - 3.2.1 Case outline(s). The case outline(s) shall be in accordance with 1.2.4 herein.
  - 3.2.2 <u>Terminal connections</u>. The terminal connections shall be as specified on figure 1.
  - 3.2.3 Block diagram. The block diagram shall be as specified on figure 2.
- 3.3 <u>Electrical performance characteristics and postirradiation parameter limits</u>. Unless otherwise specified herein, the electrical performance characteristics and postirradiation parameter limits are as specified in table I and shall apply over the full ambient operating temperature range.
- 3.4 <u>Electrical test requirements</u>. The electrical test requirements shall be the subgroups specified in table II. The electrical tests for each subgroup are defined in table I.
- 3.5 Marking. The part shall be marked with the PIN listed in 1.2 herein. Marking for device class M shall be in accordance with MIL-STD-883 (see 3.1 herein). In addition, the manufacturer's PIN may also be marked as listed in MIL-BUL-103. Marking for device classes B and S shall be in accordance with MIL-M-38510. Marking for device classes Q and V shall be in accordance with MIL-I-38535.
- 3.5.1 <u>Certification/compliance mark</u>. The compliance mark for device class M shall be a "C" as required in MIL-STD-883 (see 3.1 herein). The certification mark for device classes B and S shall be a "J" or "JAN" as required in MIL-M-38510. The certification mark for device classes Q and V shall be a "QML" as required in MIL-I-38535.
- 3.6 <u>Certificate of compliance</u>. For device class M, a certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in MIL-BUL-103 (see 6.7.3 herein). For device classes Q and V, a certificate of compliance shall be required from a QML-38535 listed manufacturer in order to supply to the requirements of this drawing (see 6.7.2 herein). The certificate of compliance submitted to DESC-EC prior to listing as an approved source of supply for this drawing shall affirm that the manufacturer's product meets, for device class M the requirements of MIL-STD-883 (see 3.1 herein), or for device classes Q and V, the requirements of MIL-I-38535 and the requirements herein.
- 3.7 <u>Certificate of conformance</u>. A certificate of conformance as required for device class M in MIL-STD-883 (see 3.1 herein) or device classes B and S in MIL-M-38510 or for device classes Q and V in MIL-I-38535 shall be provided with each lot of microcircuits delivered to this drawing.
- 3.8 <u>Notification of change for device class M</u>. For device class M, notification to DESC-EC of change of product (see 6.2 herein) involving devices acquired to this drawing is required for any change as defined in MIL-STD-480.

STANDARDIZED MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER	SIZE A		5962-91689
DAYTON, OHIO 45444		REVISION LEVEL	SHEET 4

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Test	Symbol   Conditions   -55°C ≤ T <sub>A</sub> ≤ +125°C   PWR-V <sub>CC</sub> = V <sub>CC</sub> = 12 V, R <sub>OSC</sub> =		Group A subgroup = 20 kΩ to		Device type	Lim	its	s   Unit
		PWR-V <sub>CC</sub> = V <sub>CC</sub> = 12 V, R <sub>OSC</sub> = V <sub>REF</sub> , C <sub>OSC</sub> = 2 nF, R <sub>TACH</sub> = 3 C <sub>TACH</sub> = 10 nF, all outputs of unless otherwise specifically in the control of the co	33 kΩ, unloaded, ied			Min	Max	
Supply current	Is			1,2,3	01		30.0	mA .
V <sub>CC</sub> turn-on threshold voltage	V <sub>THON</sub>			1,2,3	01	8.65	9.45	V
V <sub>CC</sub> turn-off threshold voltage	V <sub>THOFF</sub>			1,2,3	01	7.75	8.55	v
OVERVOLTAGE/COAST SE								
DV-COAST inhibit threshold voltage	  V <sub>ITH</sub> 			1,2,3	01	1.65	1.85	V
DV-COAST restart threshold voltage	  V <sub>RTH</sub> 	  T <sub>A</sub> = +25°C		1	01	1.55	1.75	   <b>v</b> 
OV-COAST hysteresis voltage	V <sub>HYS</sub>	  T <sub>A</sub> = +25°C		1	01	0.05	0.15	   V
current	IIN	T <sub>A</sub> = +25°C		1	01	-10	0	   µА
OGIC INPUTS SECTION								
11, H2, H3 low threshold voltage	V <sub>LTH</sub>	[		1,2,3	01	0.8	1.2	V
H1, H2, H3 high threshold voltage	V <sub>HTH</sub>			1,2,3	01	1.6	2.0	V
11, H2, H3 input current	IINH			1,2,3	01	-400	-120	μА
QUAD SEL, DIR threshold voltage	V <sub>TH</sub>			1,2,3	01	0.8	2.0	V
QUAD SEL hyster <del>e</del> sis voltage	QSHYS	T <sub>A</sub> = +25°C		1	01	 	130	mV
DIR hysteresis voltage	DHYS	T <sub>A</sub> = +25°C		1	01	_4	.8	V
QUAD SEL input current	INQS	T <sub>A</sub> = +25°C		1	01	-30	150	<u>μ</u> Α
DIR input current	IINDIR	  T <sub>A</sub> = +25°C		1	01	   -30 	30	μΑ
See footnote at end	of table.							
	LITARY	RDIZED DRAWING	SIZE A		· · · · · · · · · · · · · · · · · ·		596	2-9168
DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444			REVI	SION LE	EVEL	SHEE	T 5	

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Test	Symbol	Conditions   -55°C ≤ T <sub>A</sub> ≤ +125°C	- 20 10	  Group A  subgroups	Device   type	Limits		Unit
		PWR-V <sub>CC</sub> = V <sub>CC</sub> = 12 V, R <sub>OSC</sub> V <sub>REF</sub> , C <sub>OSC</sub> = 2 nF, R <sub>TACH</sub> = 10 nF, all outputs unless otherwise speci	= 20 k $\Omega$ to 33 k $\Omega$ , unloaded, fied		   	Min	Max	
PWM AMP/COMPARATOR	SECTION					<b>-</b>		<b>!</b>
E/A IN+, E/A IN- input current	I INE/A	T <sub>A</sub> = +25°C at 2.5 V		1	01	-5.0	5.0	μΑ
PWM IN input current	INPWM	T <sub>A</sub> = +25°C at 2.5 V		1	   01 	0	   30 	μΑ
Error amp input offset voltage	VINOF	0 V < V <sub>COMMON</sub> < 3 V, T <sub>A</sub> = +2	25°C	1	01	   -10	10	   mV
Error amp voltage gain	Av	T <sub>A</sub> = +25°C		   1 	01	70		dB
E/A OUT voltage range	v <sub>R</sub>	T <sub>A</sub> = +25°C		1	   01 	0.25	3.50	   V
START pull-up current	ISSPU	  T <sub>A</sub> = +25°C		1	01	-16	-5	μA
START discharge current	ISSD	T <sub>A</sub> = +25°C		1	01	0.1	3.0	mA
START restart threshold voltage	I <sub>SSR</sub>	  T <sub>A</sub> = +25°C		1	01	0.1	0.3	٧
URRENT AMP SECTION	. <u> </u>							
ain	A/V	ISENSE1 = .3 V, T <sub>A</sub> = +25°C, ISENSE2 = .5 V to .7 V		1	01	0.1	3.0	V/V
evel shift voltage	v <sub>LS</sub>	ISENSE1 = .3 V, T <sub>A</sub> = +25°C,. ISENSE2 = .3 V		1	01	2.4	2.65	V
eak current threshold voltage	V <sub>PI</sub>	ISENSE1 = 0 V, T <sub>A</sub> = +25°C, Force ISENSE2		1	01	0.14	0.26	V
ver current threshold voltage	v <sub>OI</sub>	ISENSE1 = 0 V, T <sub>A</sub> = +25°C, Force ISENSE2		1	01	0.26	0.36	V
SENSE1, ISENSE2 input current	IIIS	T <sub>A</sub> = +25°C at 0 V		1	01	-850	0	μΑ
SENSE1, ISENSE2 offset current	IOFIS	T <sub>A</sub> = +25°C at 0 V		1	01		±12	μΑ
voltage range		T <sub>A</sub> = +25°C		1	01	-1	2	٧
ee footnote at end	of table.				<b></b>		<u>_</u>	
MI	STANDAR LITARY	DRAWING	SIZE A				5962	-91689
DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444			REVISI	ON LEV	, FI	SHEET		

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Test	Symbol	Conditions   -55°C ≤ T <sub>A</sub> ≤ +125°C   PWR-V <sub>CC</sub> = V <sub>CC</sub> = 12 V, R <sub>OSC</sub>	- 20 kO +o	Group A subgroups	Device type	   Lim 	its	   Unit
		V <sub>REF</sub> , C <sub>OSC</sub> = 2 nF, R <sub>TACH</sub> = 33 kΩ, C <sub>TACH</sub> = 10 nF, all outputs unloaded, unless otherwise specified				Min	Max	 
TACHOMETER/BRAKE SEC	TION							
TACH-OUT high level voltage	V <sub>TOH</sub>	10 kΩ to 2.5 V		1,2,3	01	4.7	5.3	v
TACH-OUT low level voltage	V <sub>TOL</sub>	10 kΩ to 2.5 V		1,2,3	01		0.2	v
On time	to	T <sub>A</sub> = +25°C <u>1</u> /		9	01	170	   280 	μs
RC-BRAKE input current	I <sub>IN</sub>	T <sub>A</sub> = +25°C		1	01	-4.0		mA
Threshold to Brake, RC-BRAKE	V <sub>THB</sub>			1,2,3	01	0.8	1.2	v
Brake to hysteresis, RC-BRAKE	V <sub>THH</sub>	  T <sub>A</sub> = +25°C		1	01		0.4	٧
SPEED-IN threshold voltage	  V <sub>THS</sub>			1,2,3	01	220	290	mV
SPEED-IN input current	INS	  T <sub>A</sub> = +25°C 		1	01	-30	30	μΑ
LOW-SIDE DRIVERS SEC	TION	y						
V <sub>OH</sub> , -1 mA, Down from V <sub>CC</sub>	     	 		1,2,3	01		2.1	v
/ V <sub>OH</sub> , -50 mA, Down from V <sub>CC</sub>				1,2,3	01		2.2	V
√ <sub>OL</sub> , 1 mA	   			1,2,3	01		0.4	   V 
√ <sub>OL</sub> , 50 mA	<u> </u>			1,2,3	   01 		0.8	V
Rise/Fall time	  t <sub>r</sub> , t <sub>f</sub>	  T <sub>A</sub> = +25°C, 10% to 90% slew  into 1 nF	time, <u>1</u> /	9	01		500	   ns 
HIGH-SIDE DRIVERS SE	CTION							
V <sub>OL</sub> , 1 mA				1,2,3	01		0.4	   V 
V <sub>OL</sub> , 50 mA				1,2,3	   01 	   	1.8	   <b>v</b> 
See footnote at end	of table.					-		
		RDIZED DRAWING	SIZE				5962	2-9168
DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444			DEVI	SION LE	7777	SHEET	<del>,</del>	

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		TABLE I. <u>Electrical performance character</u>	· · · ·	it mueu.			<del>,</del>
Test	  Symbol	Conditions -55°C ≤ T <sub>A</sub> ≤ +125°C	  Group A  subgroups	Device type	Lim	Unit	
		PWR-V <sub>CC</sub> = V <sub>CC</sub> = 12 V, R <sub>OSC</sub> = 20 kΩ to   V <sub>REF</sub> , C <sub>OSC</sub> = 2 nF, R <sub>TACH</sub> = 33 kΩ,   C <sub>TACH</sub> = 10 nF, all outputs unloaded, unless otherwise specified			Min	   Max	     
HIGH-SIDE DRIVERS	SECTION - (	Continued					
Leakage current	IL	V <sub>OUT</sub> = 50 V, T <sub>A</sub> = +25°C	1	01		25	μΑ
Fall time	t <sub>r</sub> , t <sub>f</sub>	  T <sub>A</sub> = +25°C, 10% to 90% slew time, <u>1</u> /  50 mA load	9	01		500	ns
OSCILLATOR SECTION							
Frequency	  f		9,10,11	01	35	65	kHz
REFERENCE SECTION							
Output voltage	V <sub>OUT</sub>		1,2,3	01	4.7	   5.3 	   V 
Load regulation	VRLOAD	0 mA to -20 mA load, T <sub>A</sub> = +25°C	1	01	-40.0	   	mV
Line regulation	V <sub>RLINE</sub>	V <sub>CC</sub> = 10 V to 18 V, T <sub>A</sub> = +25°C	1	01	-10	   10	   mV
Short circuit	IVos		1,2,3	01	50	150	   mA

 $\underline{1}/$  Guaranteed, if not tested, to the limits specified in table I.

- 3.9 <u>Verification and review for device class M</u>. For device class M, DESC, DESC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.
- 3.10 <u>Microcircuit group assignment for device classes M, B, and S</u>. Device classes M, B, and S devices covered by this drawing shall be in microcircuit group number 55 (see MIL-M-38510, appendix E).
  - 3.11 <u>Serialization for device class S</u>. All device class S devices shall be serialized in accordance with MIL-M-38510.
  - 4. QUALITY ASSURANCE PROVISIONS
- 4.1 <u>Sampling and inspection</u>. For device class M, sampling and inspection procedures shall be in accordance with section 4 of MIL-M-38510 to the extent specified in MIL-STD-883 (see 3.1 herein). For device classes B and S, sampling and inspection procedures shall be in accordance with MIL-M-38510 and method 5005 of MIL-STD-883, except as modified herein. For device classes Q or V, sampling and inspection procedures shall be in accordance with MIL-I-38535 and the device manufacturer's QM plan.
- 4.2 <u>Screening</u>. For device class M, screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. For device classes B and S, screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to qualification and quality conformance inspection. For device classes Q and V, screening shall be in accordance with MIL-I-38535, and shall be conducted on all devices prior to qualification and technology conformance inspection.

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# Case outline X

Device type	01					
Case outline	   x					
_Terminal number	Terminal symbol					
1 2	E/A IN+					
3	VREF I-SENSE					
4	ISENSE1					
5	ISENSE2					
6	DIR					
<b>7</b> . i	SPEED-IN					
8	H1					
9	н2					
10	н3					
11	PWR-V <sub>CC</sub>					
12	PD <sub>C</sub> "					
13	PD <sub>B</sub>					
14	PDA					
15	GROÙND					
16	PU <sub>C</sub>					
17	PUB					
18	PUA					
19	VCC					
20	TACH-OUT					
21	RC-BRAKE					
22	QUAD-SEL					
23	OV-COAST					
24	S START					
25	RC-OSC					
26	PWM IN					
27 28	E/A OUT E/A IN-					

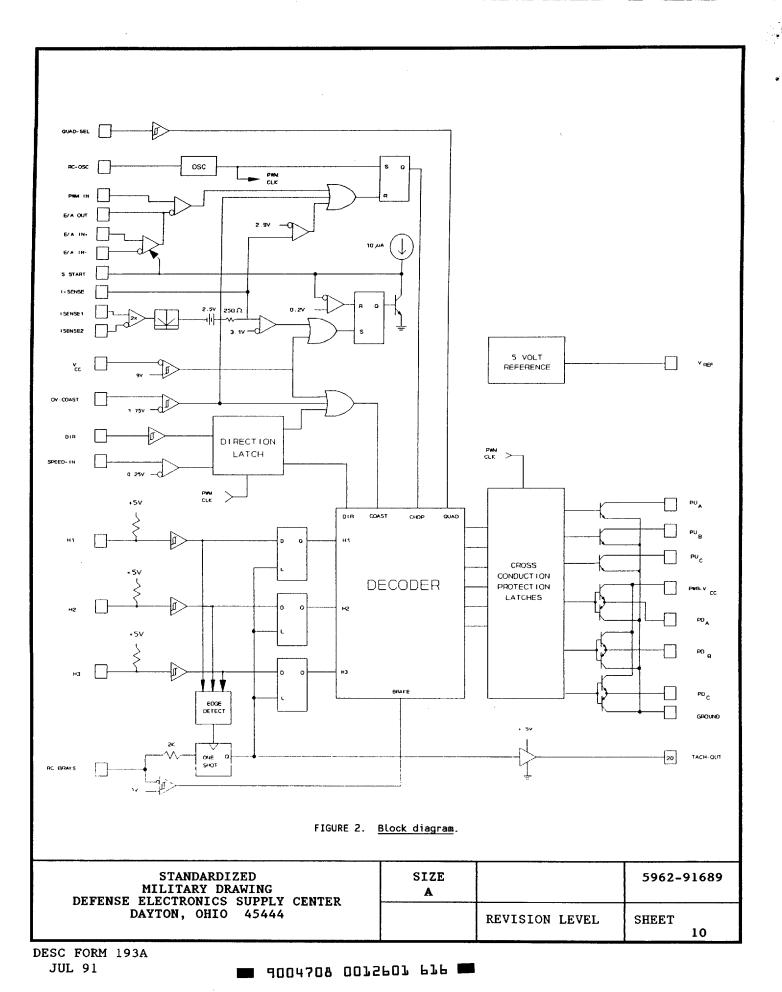
FIGURE 1. <u>Terminal connections</u>.

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TABLE II. Electrical test requirements.

Test requirements	with M	ups (in ac IL-STD-883 table I)	Subgroups (in accordance  with MIL-I-38535,  table III)		
	Device class M	Device class B	Device   class   S	Device class	Device   class   V
Interim electrical parameters (see 4.2)	1	   1 	1	   1 	1
   Final electrical   parameters (see 4.2)	1/ 1,2,3	   <u>1</u> /   1,2,3	1/ 1,2,3	1/ 1,2,3	1/ 1,2,3
Group A test requirements (see 4.4)	   <u>2</u> /   1,2,3,   9,10,11	   <u>2</u> /   1,2,3,   9,10,11	   <u>2</u> /   1,2,3,   9,10,11	   <u>2</u> /   1,2,3,   9,10,11	   <u>2</u> /   1,2,3,   9,10,11
Group B end-point electrical parameters (see 4.4)			1,2,3		
Group C end-point electrical parameters (see 4.4)	1,2,3	1,2,3	1,2,3	1,2,3	1,2,3
Group D end-point electrical parameters (see 4.4)	1	1	1	1,2,3	1,2,3
Group E end-point electrical parameters (see 4.4)					

- 1/ PDA applies to subgroup 1.
- $\overline{2}$ / Subgroups 9, 10, and 11 are guaranteed, if not tested, to the limits specified in table I.

## 4.2.1 Additional criteria for device classes M, B, and S.

- a. Burn-in test, method 1015 of MIL-STD-883.
  - (1) Test condition A, B, C, or D. For device class M, the test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. For device classes B and S, the test circuit shall be submitted to the qualifying activity. For device classes M, B, and S, the test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1015.
  - (2)  $T_A = +125$ °C, minimum.
- b. Interim and final electrical test parameters shall be as specified in table II herein.

### 4.2.2 Additional criteria for device classes Q and V.

- a. The burn-in test duration, test condition and test temperature, or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-I-38535. The burn-in test circuit shall be maintained under document revision level control of the device manufacturer's Technology Review Board (TRB) in accordance with MIL-I-38535 and shall be made available to the acquiring or preparing activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1015.
- b. Interim and final electrical test parameters shall be as specified in table II herein.
- c. Additional screening for device class V beyond the requirements of device class Q shall be as specified in appendix B of MIL-I-38535.

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## 4.3 Qualification inspection.

- 4.3.1 Qualification inspection for device classes B and S. Qualification inspection for device classes B and S shall be in accordance with MIL-N-38510. Inspections to be performed shall be those specified in method 5005 of MIL-STD-883 and herein for groups A, B, C, D, and E inspections (see 4.4.1 through 4.4.5).
- 4.3.2 <u>Qualification inspection for device classes Q and V</u>. Qualification inspection for device classes Q and V shall be in accordance with MIL-I-38535. Inspections to be performed shall be those specified in MIL-I-38535 and herein for groups A, B, C, D, and E inspections (see 4.4.1 through 4.4.5).
- 4.4 <u>Conformance inspection</u>. Quality conformance inspection for device class M shall be in accordance with MIL-STD-883 (see 3.1 herein) and as specified herein. Quality conformance inspection for device classes B and S shall be in accordance with MIL-M-38510 and as specified herein. Inspections to be performed for device classes M, B, and S shall be those specified in method 5005 of MIL-STD-883 and herein for groups A, B, C, D, and E inspections (see 4.4.1 through 4.4.5). Technology conformance inspection for classes Q and V shall be in accordance with MIL-I-38535 including groups A, B, C, D, and E inspections and as specified herein except where option 2 of MIL-I-38535 permits alternate in-line control testing.

## 4.4.1 Group A inspection.

- a. Tests shall be as specified in table II herein.
- b. Subgroups 4, 5, 6, 7 and 8 in table I, method 5005 of MIL-STD-883 shall be omitted.
- 4.4.2 <u>Group B inspection.</u> The group B inspection end-point electrical parameters shall be as specified in table II herein. For device class S steady-state life tests, the test circuit shall be submitted to the qualifying activity.
- 4.4.3 <u>Group C inspection</u>. The group C inspection end-point electrical parameters shall be as specified in table II herein.
- 4.4.3.1 <u>Additional criteria for device classes M and B</u>. Steady-state life test conditions, method 1005 of MIL-STD-883:
  - a. Test condition A, B, C, or D. For device class M, the test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. For device class B, the test circuit shall be submitted to the qualifying activity. For device classes M and B, the test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1005.
  - b.  $T_A = +125$ °C, minimum.
  - c. Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.
- 4.4.3.2 Additional criteria for device classes Q and V. The steady-state life test duration, test condition and test temperature, or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-I-38535. The test circuit shall be maintained under document revision level control by the device manufacturer's TRB in accordance with MIL-I-38535 and shall be made available to the acquiring or preparing activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1005.
- 4.4.4 Group D inspection. For group D inspection end-point electrical parameters shall be as specified in table II herein.
- 4.4.5 <u>Group E inspection</u>. Group E inspection is required only for parts intended to be marked as radiation hardness assured (see 3.5 herein). RHA levels for device classes B, S, Q, and V shall be M, D, R, and H and for device class M shall be M and D.
  - a. End-point electrical parameters shall be as specified in table II herein.
  - b. For device classes M, B, and S, the devices shall be subjected to radiation hardness assured tests as specified in MIL-M-38510 for the RHA level being tested. For device classes Q and V, the devices or test vehicle shall be subjected to radiation hardness assured tests as specified in MIL-I-38535 for the RHA level being tested. All device classes must meet the postirradiation end-point electrical parameter limits as defined in table I at  $T_A = +25^{\circ}\text{C}$   $\pm 5^{\circ}\text{C}$ , after exposure, to the subgroups specified in table II herein.

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### PACKAGING

5.1 <u>Packaging requirements</u>. The requirements for packaging shall be in accordance with MIL-M-38510 for device classes M, B, and S and MIL-I-38535 for device classes Q and V.

#### 6. NOTES

- 6.1 <u>Intended use</u>. Microcircuits conforming to this drawing are intended for use for Government microcircuit applications (original equipment), design applications, and logistics purposes.
- 6.1.1 <u>Replaceability</u>. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.
  - 6.1.2 <u>Substitutability</u>. Device classes B and Q devices will replace device class M devices.
- 6.2 <u>Configuration control of SMD's</u>. All proposed changes to existing SMD's will be coordinated with the users of record for the individual documents. This coordination will be accomplished in accordance with MIL-STD-481 using DD Form 1693, Engineering Change Proposal (Short Form).
- 6.3 <u>Record of users</u>. Military and industrial users shall inform Defense Electronics Supply Center when a system application requires configuration control and which SMD's are applicable to that system. DESC will maintain a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronic devices (FSC 5962) should contact DESC-EC, telephone (513) 296-6047.
- 6.4 Comments. Comments on this drawing should be directed to DESC-EC, Dayton, Ohio 45444, or telephone (513) 296-5377.
- 6.5 <u>Abbreviations, symbols, and definitions</u>. The abbreviations, symbols, and definitions used herein are defined in MIL-M-38510 and MIL-STD-1331.
- 6.6 One part one part number system. The one part one part number system described below has been developed to allow for transitions between identical generic devices covered by the four major microcircuit requirements documents (MIL-M-38510, MIL-H-38534, MIL-I-38535, and 1.2.1 of MIL-STD-883) without the necessity for the generation of unique PIN's. The four military requirements documents represent different class levels, and previously when a device manufacturer upgraded military product from one class level to another, the benefits of the upgraded product were unavailable to the Original Equipment Manufacturer (OEM), that was contractually locked into the original unique PIN. By establishing a one part number system covering all four documents, the OEM can acquire to the highest class level available for a given generic device to meet system needs without modifying the original contract parts selection criteria.

Military documentation format	Example PIN under new system	Manufacturing source listing	Document Listing
New MIL-M-38510 Military Detail Specifications (in the SMD format)	5962-XXXXXZZ(B or S)YY	QPL-38510 (Part 1 or 2)	MIL-BUL-103
New MIL-H-38534 Standardized Military Drawings	5962-XXXXXZZ(H or K)YY	QML-38534	MIL-BUL-103
New MIL-I-38535 Standardized Military Drawings	5962-XXXXXZZ(Q or V)YY	QML-38535	MIL-BUL-103
New 1.2.1 of MIL-STD-883 Standardized Military Drawings	5962-XXXXXZZ(M)YY	MIL-BUL-103	MIL-BUL-103

### 6.7 Sources of supply.

- 6.7.1 <u>Sources of supply for device classes B and S</u>. Sources of supply for device classes B and S are listed in QPL-38510.
- 6.7.2 <u>Sources of supply for device classes Q and V</u>. Sources of supply for device classes Q and V are listed in QML-38535. The vendors listed in QML-38535 have submitted a certificate of compliance (see 3.6 herein) to DESC-EC and have agreed to this drawing.
- 6.7.3 Approved sources of supply for device class M. Approved sources of supply for class M are listed in MIL-BUL-103. The vendors listed in MIL-BUL-103 have agreed to this drawing and a certificate of compliance (see 3.6 herein) has been submitted to and accepted by DESC-EC.

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